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🛛 2A1

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- pnp Inputs Reduce dc Loading
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

These octal buffers/drivers are designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The designer has a choice of selected combinations of inverting and noninverting outputs, symmetrical active-low output-enable (\overline{OE}) inputs, and complementary OE and \overline{OE} inputs. These devices feature high fan-out and improved fan-in.

The -1 version of SN74ALS241C is identical to the standard version, except that the recommended maximum I_{OL} of the -1 version is 48 mA. There is no -1 version of the SN54ALS241C.

The SN54ALS241C and SN54AS241A are characterized for operation over the full military temperature range of -55° C to 125° C. The SN74ALS241C and SN74AS241A are characterized for operation from 0°C to 70°C.

(TOP VI	EW)	
10E [20	Vcc
1A1 [19	20E
2Y4 [3	18	1Y1
1A2 [2A4
2Y3 [16	1Y2
1A3 [2A3
2Y2 [1A4 [7		1Y3
1A4 [8	13	2A2

SN54ALS241C, SN54AS241A ... J PACKAGE

SN74ALS241C, SN74AS241A . . . DW OR N PACKAGE

SN54ALS241C, SN54AS241A ... FK PACKAGE (TOP VIEW)

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GND 🛛

		2Y4	1A1	10E	^CC	20E			
1A2 2Y3 1A3 2Y2 1A4	4 5 6 7 8	3			20	· · ·	18 17 16 15 14	1Y1 2A4 1Y2 2A3 1Y3	
	-	2Y1	GND	2A1	174	2A2	07	SC	

	FUI		TABLES
-	INP	UTS	OUTPUT
1	10E	1A	1Y
	L	Н	Н
	L	L	L
	н	Х	Z

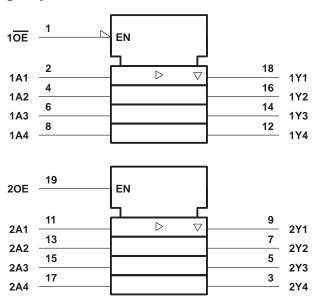
INPU	JTS	OUTPUT
20E	2A	2Y
Н	Н	н
н	L	L
Adg. o	Х	Z



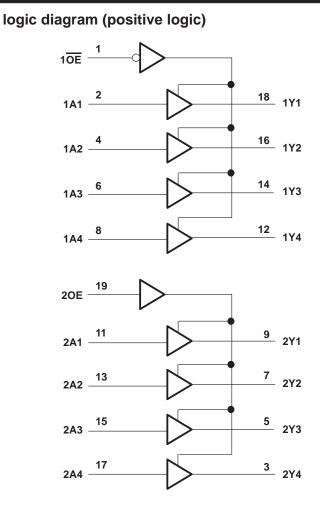


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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage, V _{CC}	
Voltage applied to a disabled 3-state output	
Operating free-air temperature range, T _A : SN54ALS241C	°C to 125°C
SN74ALS241C	0°C to 70°C
Storage temperature range	°C to 150°C

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



SN54ALS241C, SN54AS241A, SN74ALS241C, SN74AS241A **OCTAL BUFFERS/DRIVERS** WITH 3-STATE OUTPUTS SDAS153E – DECEMBER 1982 – REVISED AUGUST 1995

recommended operating conditions

		SN	54ALS24	1C	SN74ALS241C			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.7			0.8	V
IOH	High-level output current			-12			-15	mA
				12			24	mA
IOL	Low-level output current						48†	ШA
TA	Operating free-air temperature	-55		125	0		70	°C

[†] Applies only to the -1 version and only if V_{CC} is between 4.75 V and 5.25 V

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEOT	CONDITIONS	SNS	54ALS24	1 C	SN74ALS241C			UNIT
PARAMETER	IESI	CONDITIONS	MIN	TYP‡	MAX	MIN	typ‡	MAX	UNIT
VIK	V _{CC} = 4.5 V,	lı = –18 mA			-1.2			-1.2	V
	V _{CC} = 4.5 V to 5.5 V,	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2	2		V _{CC} -2	2		
Vou		$I_{OH} = -3 \text{ mA}$	2.4	3.2		2.4	3.2		V
VOH	$V_{CC} = 4.5 V$	I _{OH} = -12 mA	2						v
		I _{OH} = -15 mA				2			
		I _{OL} = 12 mA		0.25	0.4		0.25	0.4	
VOL	$V_{CC} = 4.5 V$	I _{OL} = 24 mA					0.35	0.5	V
		I _{OL} = 48 mA (-1 version)					0.35	0.5	
IOZH	V _{CC} = 5.5 V,	V _O = 2.7 V			20			20	μA
IOZL	V _{CC} = 5.5 V,	$V_{O} = 0.4 V$			-20			-20	μΑ
lj	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA
IН	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μΑ
١ _{١L}	V _{CC} = 5.5 V,	VI = 0.4 V			-0.1			-0.1	mA
١ _O §	V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA
		Outputs high		9	17		9	18	
Icc	V _{CC} = 5.5 V	Outputs low		15	28		15	26	mA
		Outputs disabled		17	32		17	30	

[‡] All typical values are at V_{CC} = 5 V, $T_A = 25^{\circ}C$.

§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.



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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	С _І R1 R2 Т ₄	$V_{CC} = 4.5 V \text{ to } 5.5 V,$ $C_{L} = 50 \text{ pF},$ $R1 = 500 \Omega,$ $R2 = 500 \Omega,$ $T_{A} = \text{MIN to MAX}^{\dagger}$ SN54ALS241C SN74ALS241C				
			MIN	MAX	MIN	MAX		
^t PLH	A	Y	3	31	2	11	ns	
^t PHL		T	1	17	3	10	115	
^t PZH	1 0E	V	3	33	3	21	ns	
^t PZL	10E	Y	3	27	4	21	115	
^t PHZ	405	X	2	17	1	10	ns	
^t PLZ	1 0E	Y	2	32	2	15	115	
^t PZH	005	X	3	38	4	21		
tPZL	20E	Y	3	30	5	21	ns	
^t PHZ	20E	Y	2	17	2	10		
^t PLZ	20E	ŕ	3	35	3	15	ns	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage, V _{CC}	
Input voltage, V _I	7 V
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, T _A : SN54AS241A	-55°C to 125°C
SN74AS241A	0°C to 70°C
Storage temperature range	-65°C to 150°C

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN	SN54AS241A SN74AS241A		UNIT			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	V
IOH	High-level output current			-12			-15	mA
IOL	Low-level output current			48			64	mA
TA	Operating free-air temperature	-55		125	0		70	°C



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DADAMETER	TEAT A	ONDITIONS	SN54AS241A		SN	74AS24 [,]	1A	UNIT	
PARAMETER	TESTC	ONDITIONS	MIN	TYP†	MAX	MIN	TYP†	MAX	
VIK	V _{CC} = 4.5 V,	l _l = –18 mA			-1.2			-1.2	V
	$V_{CC} = 4.5 V \text{ to } 5.5 V,$	$I_{OH} = -2 \text{ mA}$	V _{CC} -2	2		V _{CC} -2	2		
Vari		$I_{OH} = -3 \text{ mA}$	2.4	3.4		2.4	3.4		v
VOH	$V_{CC} = 4.5 V$	I _{OH} = -12 mA	2.4						v
		I _{OH} = -15 mA				2.4			
Ve		I _{OL} = 48 mA		0.27	0.55				.55 V
VOL	$V_{CC} = 4.5 V$	I _{OL} = 64 mA					0.31	0.55	
IOZH	V _{CC} = 5.5 V,	V _O = 2.7 V			50			50	μA
IOZL	V _{CC} = 5.5 V,	V _O = 0.4 V			-50			-50	μA
Ц	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA
Чн	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μA
۱ _{IL}	V _{CC} = 5.5 V,	V _I = 0.4 V			-1			-1	mA
IO‡	V _{CC} = 5.5 V,	V _O = 2.25 V	-50		-150	-50		-150	mA
		Outputs high		22	35		22	35	
ICC	V _{CC} = 5.5 V	Outputs low		61	90		61	90	mA
		Outputs disabled		35	56		35	56	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. [‡] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

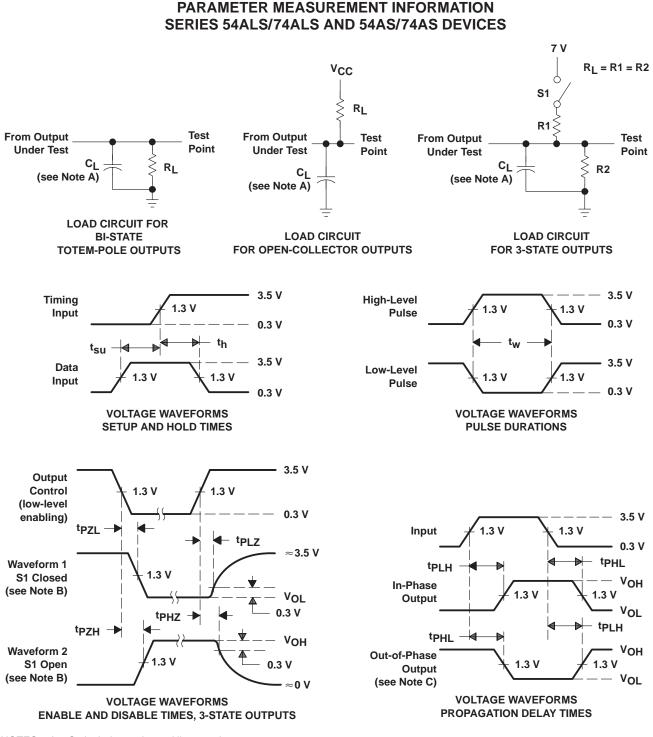
switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	F F	$V_{CC} = 4.5 V \text{ to } 5.5 V,$ $C_{L} = 50 \text{ pF},$ $R1 = 500 \Omega,$ $R2 = 500 \Omega,$ $T_{A} = \text{MIN to MAX}$ $SN54AS241A \text{ SN74AS241A}$			
			MIN	MAX	MIN	MAX	
^t PLH			2	9	2	6.2	
tPHL	A	Y	1	7	1	6.2	ns
^t PZH			1	10	1	9	
^t PZL	1 0E	Y	2	8	2	7.5	ns
^t PHZ	405	, v	1	6.5	1	6	
^t PLZ	1 <mark>0</mark> E	Y	1	10.5	1	9	ns
^t PZH	205	, v	2	11	2	10.5	
tPZL	20E	Y	3	9.5	3	8.5	ns
^t PHZ	20E	Y	1	7	1	7	
^t PLZ	20E	T	2	12	2	12	ns

§ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_{f} = t_{f} = 2 ns, duty cycle = 50\%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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